

A tri-mode event-based vision sensor with an embedded wireless transmitter

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Abstract—We report a vision sensor with three different operation modes (intensity, spatial, and temporal contrast), and an integrated UWB wireless transmitter. The sensor is intended for surveillance applications in Wireless Sensor Networks (WSN), where autonomous sensor nodes are required. It has event-based output, high dynamic range (120dB), and reduced power consumption (we expect less than 2.7mA for the sensor and 10mA for the wireless transmitter). Its pixels only use 5 transistors and have a size of $10 \times 10 \mu\text{m}^2$, with fill factor of 47%. The sensor array has 256×256 pixels and was implemented in the standard IBM 8HP SiGe BiCMOS $0.13 \mu\text{m}$ process. In this paper, we describe the system blocks. Simulation and preliminary experimental results are provided.

I. INTRODUCTION

There is a high demand of low-cost and compact vision systems with high dynamic range of operation and reduced output data flow. This demand is partially due to the development of WSNs (Wireless Sensor Networks). Such networks are used for plenty of tasks like surveillance, home-care, or industrial applications [1]–[3]. WSNs require smart autonomous devices with reduced power consumption and compressed data flow. These sensors should only send meaningful information to a central node when necessary. In that sense, devices that detect either spatial or the temporal contrast, trying to emulate the human retina, provide a very reduced data flow, preserving the relevant information to perform recognition. AER (Address Event Representation) sensors are quite suitable for WSNs because their outputs are typically voltage pulses (events) that can be easily conveyed into radio signals and transmitted wirelessly. Several relevant bio-inspired vision sensors with low power consumption and reduced data flow have been published [4]–[7], but none of them was specifically conceived to be a WSN autonomous node.

In this paper, we present an improved version of the tri-operation vision sensor presented by D. Kim et al. [8]. That sensor had three different operation modes (spatial, temporal and intensity mode), reduced power consumption, and good fill factor (42%). The new imager has an integrated wireless transmitter for its usage in WSNs, higher dynamic range (40dB higher employing dual rolling shutter and a floating

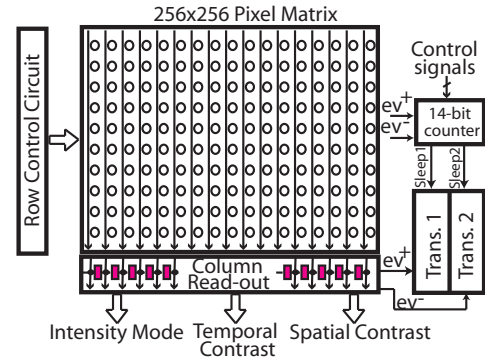


Fig. 1. System topology.

diffusion storage capacitor [9]), smaller pixels with only 5 transistors, and higher resolution (256×256).

The device was implemented in the IBM 8HP SiGe BiCMOS $0.13 \mu\text{m}$ process. It is the first vision sensor with three operation modes and an integrated wireless transmitter. In the next sections, we will describe the main system circuit blocks. Some simulation and preliminary experimental results will be shown.

II. SYSTEM TOPOLOGY

Fig. 1 shows the main system blocks. The array has 256×256 pixels. The row control circuitry implements dual rolling electronic shutter for the row control signals activation. Contrast computation (either spatial or temporal) is done off-pixel in the column units. Each column read-out unit contains the circuitry to calculate the spatial or the temporal contrast, and also comparators to generate signed events. The sensor can detect the sign of the contrast and has two independent outputs for each sign (ev^+ and ev^-). These outputs are connected to two wireless transmitters that send out UWB pulses. A 256-bit pattern is always transmitted at the end of each frame to recover the clock synchronism and determine the end of each frame. Finally, a 14-bit counter has been added to the design. It counts the number of events of each frame. If the number of events is quite low (below 2.5% or 5% total number of

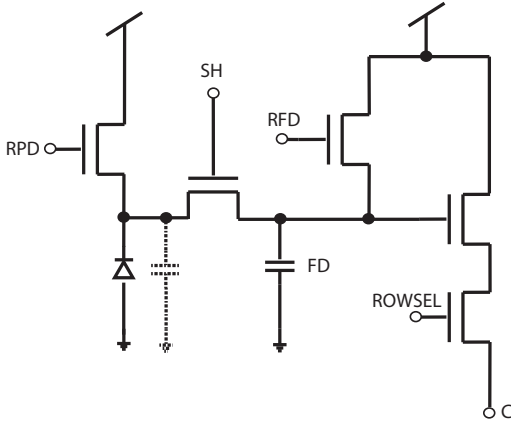


Fig. 2. Pixel Design.

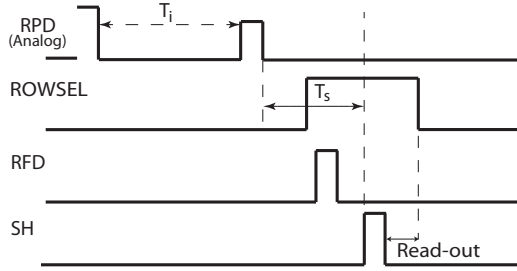


Fig. 3. Timing diagram of the pixel control signals.

pixels) and there is no meaningful information to transmit, the wireless transmitters can be temporary disabled. Therefore, energy is saved and bandwidth consumption reduced. When the sensor generates frames with relevant information, the transmitter can be enabled again. In the two next sections, we will describe the circuitry of each main block and its functionalities.

A. Pixel Design

Fig. 2 shows the pixel topology of the sensor. Each pixel is made up by 5 transistors and 1 floating diffusion (FD) capacitor. Pixel size is $10 \times 10 \mu\text{m}^2$ with a fill factor of

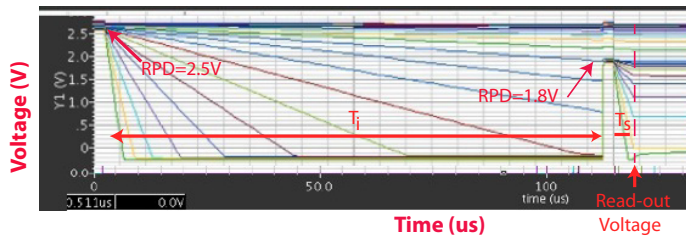


Fig. 4. Transient simulation of the voltage at the parasitic photo diode capacitance of several pixels exposed to very different levels of illumination. A partial reset of $RPD = 1.8\text{V}$ was applied to increase dynamic range. Control signals were activated as is depicted in Fig. 3.

47%. All the contrast computation is done off-pixel. The main novelty of the new pixel is the partial reset analog signal, RPD , that allows to increase the dynamic range of operation of the sensor during two integration times: T_i and T_s . Fig. 3 depicts how the control signals are activated to perform the partial reset operation. Fig. 4 shows a transient simulation of the photo-diode parasitic capacitance voltage of several pixels exposed to very different levels of illumination.

The principle of operation is as follows: First, the photo diode capacitance is reset completely setting $RPD = 2.5\text{V}$. Then we set $RPD = 0\text{V}$ and charge is integrated during an integration time T_i . After, we partially reset the integrated charge activating the analog RPD signal again. We set $RPD = 1.8\text{V}$ in the simulation. Then, we continue integrating charge during a shorter time interval, T_s . Finally, the signals, RFD , SH , and $ROWSEL$ are activated sequentially to reset the floating diffusion, transfer the charge to the floating diffusion, and read-out the integrated charge. Dynamic range of operation is extended with this operation. Without the partial reset, some pixels high illumination would provide the same output voltage close to 0V . After the partial reset operation, their output voltages are within the interval V_{DD} and V_{GND} and, therefore, dynamic range is extended. Integrated charge of pixels with low illumination is not affected significantly by the partial reset (see Fig. 4). In the simulation, $T_i/T_s = 20$. Computing the ratio of the lowest and the highest photo current, that would saturate without the partial reset operation, the increase of the dynamic range was 24dB . With this operation, a maximum increase of 40dB [9] is expected when $T_i/T_s = 100$.

B. Column Units and Operation Modes

This is the main operation module of the sensor. There are 256 column units (see Fig. 1). The column unit block diagram is depicted in Fig. 5. Each one is connected to the pixels of its row and the adjacent one. The signal $COLSEL$ is a token that activates the column under selection and then is transferred to the next column with shift registers. There are one WTA (Winner Takes All) and one LTA (Looser Takes All) block to calculate the spatial contrast [8]. A VGA (Variable Gain Amplifier) is employed to amplify the spatial difference in voltage between 4 neighboring pixels or the temporal pixel voltage variations in two consecutive integration intervals. Finally, two comparators send out positive or negative events. The circuitry of the WTA and LTA blocks, and the VGA circuitry are shown in Fig 6.(a) and Fig. 6.(b) respectively. The three operation modes are described below:

Intensity mode: The output voltage is connected with a switch, activated with the signal $COLSEL$, to a global buffer that sends out the chip the read-out voltage. The global buffer can be switched-off if the intensity mode is not activated.

Temporal mode: The difference between the pixel read-out voltage in two consecutive integration periods is amplified. The time-line of the control signals is displayed in Fig. 7(a). Control signals $SRST$ and ST_1 are involved. The read-out voltage value is stored in the floating diffusion. The temporal voltage difference between the stored voltage value and the

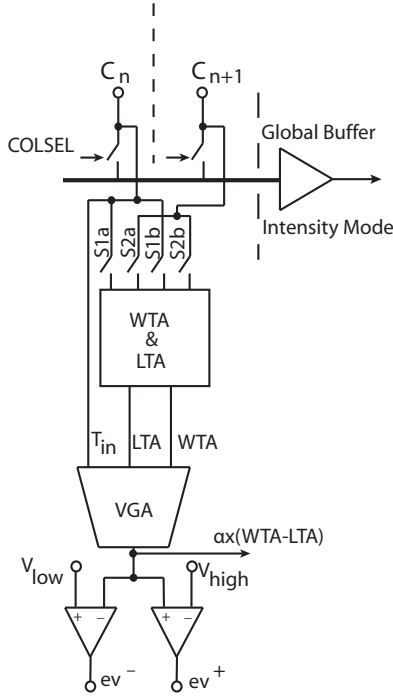


Fig. 5. Column unit block diagram. Each matrix pixel is connected to a column unit. This block calculates spatial or temporal contrast.

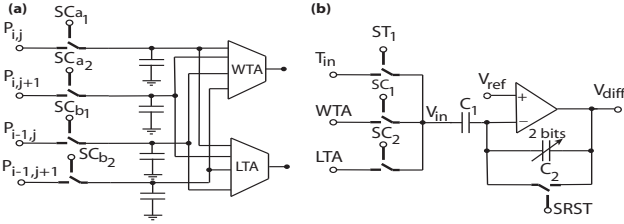


Fig. 6. (a) WTA and LTA blocks and control signals to store the voltage read-out values of four adjacent pixels. (b) VGA circuit and control signals used to amplify the difference between the WTA and LTA blocks (spatial contrast), or the temporal difference between two consecutive pixel outputs (temporal contrast).

latest read-out voltage is amplified with the VGA. This is proportional to the temporal contrast. Each row is selected and read-out twice in consecutive intervals.

Spatial mode: Spatial contrast is calculated with WTA and LTA operations amplifying the difference of the output voltage of 4 neighboring pixels as explained in [8]. The WTA and LTA blocks are used to amplify the difference between the read-out voltage of four adjacent pixels: $P_{i,j}$, $P_{i,j+1}$, $P_{i+1,j}$, and $P_{i+1,j+1}$. The control signals SC_{1a} , SC_{2a} , SC_{1b} , SC_{2b} are activated as is depicted on the time-line of Fig. 7. First, the voltage of the selected pixel and the voltage of its right neighbor are stored at the input capacitors of the WTA and LTA blocks (see Fig 6.(a)). Then, when the next row is selected, the voltages of the bottom pixels $P_{i+1,j}$, and $P_{i+1,j+1}$ are stored in the same way. Finally, the voltage difference of the WTA and LTA blocks is amplified with the

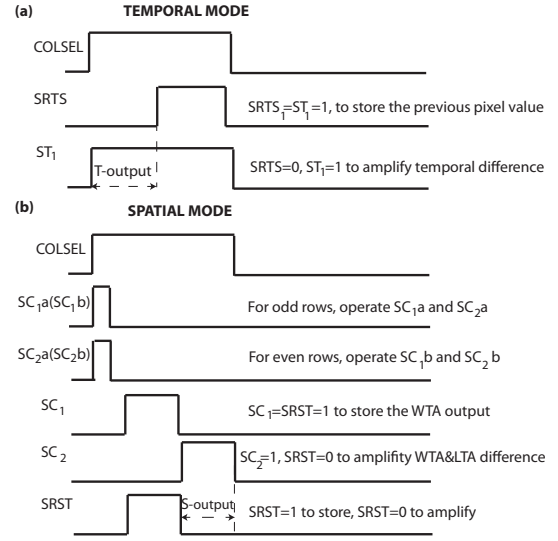


Fig. 7. Control signals employed to compute the temporal and the spatial contrast in the column units.

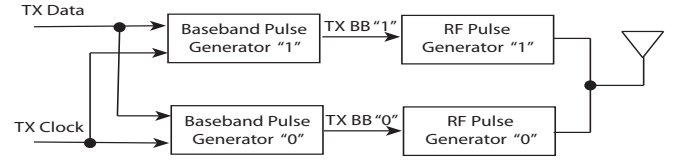


Fig. 8. Block diagram of the non-coherent FSK-OOK wireless transmitter.

VGA. There are two tokens signals to store alternately the values of the even and the odd rows.

The VGA outputs are connected to two comparators that send out positive or negative events when a positive, V_{high} , or a negative threshold, V_{low} are exceeded. The VGA gain can be adjusted with 2 control bits that set the value of the capacitor C_2 .

C. Wireless Transmitter

Two FSK-OOK transmitters [10] are embedded in the image sensor to wirelessly send out real-time events in temporal and spatial contrast modes. One transmits the positive event output ev^+ and the another one transmits the negative event output ev^- . They can be independently disabled or switched off. Bits "1" and "0" are up-converted to $600MHz$ and $2GHz$, respectively with ring oscillators. A time slot is inserted between two consecutive bits. The transmitter is shut down automatically when there is no data to send. The received binary data can be recovered with a non coherent FSK-OOK demodulator. The advantage of using FSK-OOK modulation is to achieve clock and data recovery automatically without synchronization. The wireless unit can transmit data asynchronously so the event rate can change during communication. A block diagram of the transmitter is shown in Fig. 8. The maximum output rate of this wireless system is $20Mbps$, which is limited by multi path and environmental noise. Each integrated transmitter occupies

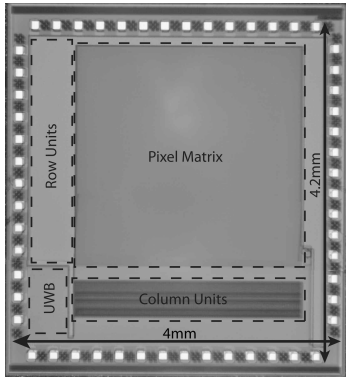


Fig. 9. Chip microphotograph. Dimensions are $4 \times 4.2\text{mm}^2$. The main circuit blocks have been highlighted.



Fig. 10. On the left, experimental setup. On the right, dedicated C++ interface displaying an intensity image taken with indoor illumination of 400lux .

$180 \times 120\mu\text{m}^2$ silicon area and consumes 10mA current when it is enabled. To indicate to the receptor the end of each frame and identify each smart node of the WSN, a 'dummy row' is transmitted at the end of each frame. It is a 256-bit programmable pattern.

III. EXPERIMENTAL RESULTS

The chip was fabricated in IBM 8HP SiGe BiCMOS $0.13\mu\text{m}$ process. Fig. 9 displays the fabricated die and the location of the main circuit blocks. The intensity operation mode was tested successfully. We are currently testing the other two operation modes and the UWB transmitter. In Fig. 10, we can see the experimental setup. A dedicated board was designed. A custom C++ interface was programmed to control all the sensor biases and show real-time images. An Opal Kelly 3010 board is attached to the chip PCB. It controls all the communication with the dedicated interface through an USB port. On the right of Fig. 10, we show the interface displaying an intensity image. Table I summarizes the main chip specifications.

IV. ACKNOWLEDGMENTS

Fabrication was supported by MOSIS Educational Program. We thank Dongsoo for proposing the imager architecture.

V. CONCLUSIONS

A new sensor targeted for Wireless Sensor Networks has been presented. It is the first vision sensor with an integrated

Array size	256×256
Technology	IBM 8HP SiGe BiCMOS $0.13\mu\text{m}$
Power supply	2.5V
Chip size	$4 \times 4.2\text{mm}^2$
Pixel size	$10 \times 10\mu\text{m}^2$
Fill factor	47%
Power consumption (I,S,T, modes)	$650\mu\text{A}$, 2.7mA , 1.2mA
Transmitter power consumption	10mA
Frame rate (I,S,T, modes)	150/800/200 <i>fps</i>
Maximum event rate	53 <i>Meps</i>
Max. wireless event rate	20 <i>Meps</i>
Dynamic range	120dB, extension of 40dB

TABLE I
SYSTEM SPECIFICATIONS

a wireless transmitter and three different operation modes (intensity mode, and spatial and temporal contrast extraction). It was designed for surveillance applications. Its main features are: 256×256 pixels resolution, $10 \times 10\mu\text{m}^2$ pixel size, fill factor of 47%, and low power consumption. Expected power consumption is 2.7mA , in spatial contrast mode, and 1.2mA , when computes the temporal contrast. In these two operation modes, a very reduced output event flow is transmitted to the processing nodes. Dynamic range of operation it is expected to be increased 40dB using partial reset operation during two integration periods. The wireless transmitter has a maximum output rate of 20 *Meps* and a power consumption of 10mA . The chip was fabricated in the standard IBM 8HP SiGe BiCMOS $0.13\mu\text{m}$ process. Some simulation and preliminary experimental results are provided.

REFERENCES

- [1] R. Szewczyk, E. Osterweil, J. Polastre, M. Hamilton, A. Mainwaring, and D. Estrin, "Habitat monitoring with sensor networks," *Communications of the ACM*, vol. 47, pp. 34–41, June 2004.
- [2] M. Duarte and H. Yu, "Vehicle classification in distributed sensor networks," *Journal of Parallel and Distributed Computing*, vol. 64, pp. 826–839, July 2004.
- [3] R. J. Nemzek and J. Dreicer, "Distributed sensor networks for detection of mobile radioactive sources," *IEEE Transactions on Nuclear Science*, vol. 51, pp. 1693–1701, August 2004.
- [4] J. A. Leñero-Bardallo, T. Serrano-Gotarredona, and B. Linares-Barranco, "A 5-decade dynamic range ambient-light-independent calibrated signed-spatial-contrast aer retina with 0.1ms latency and optional time-to-first-spike mode," *Transactions on Circuits and Systems, Part-I*, 2010.
- [5] P.-F. R. et al., "An SoC combining a 132dB QVGA pixel array and a 32b DSP/MCU processor for vision applications," in *International Solid State Circuits Conference, ISSCC*, 2009, pp. 46–47.
- [6] P. Lichtsteiner, C. Posch, and T. Delbruck, "An 128x128 120dB 15us-latency temporal contrast vision sensor," *IEEE J. Solid State Circuits*, vol. 43, no. 2, pp. 566–576, 2007.
- [7] J. A. Leñero-Bardallo, T. Serrano-Gotarredona, and B. Linares-Barranco, "A $3.6\mu\text{s}$ latency asynchronous frame-free event-driven dynamic-vision-sensor," *IEEE Journal of Solid-State Circuits*, vol. 46, no. 6, pp. 1443–1455, June 2011.
- [8] D. Kim and E. Culurciello, "A compact-pixel tri-mode vision sensor," in *ISCAS*, 2010, pp. 2434 – 2437.
- [9] D. Kim, Y. Chae, J. Cho, and G. Han, "A dual-capture wide dynamic range CMOS image sensor using floating diffusion capacitor," *IEEE Transaction on Electron Devices*, vol. 55, no. 10, pp. 2590–2594, October 2008.
- [10] W. Tang and E. Culurciello, "A non-coherent FSK-OOK UWB impulse radio transmitter for clock-less synchronization," in *ISCAS*, 2011, pp. 1295–1298.